400 Watt Peak Power Zener Transient Voltage Suppressors

Bidirectional*

The SMA series is designed to protect voltage sensitive components from high voltage, high energy transients. They have excellent clamping capability, high surge capability, low zener impedance and fast response time. The SMA series is supplied in ON Semiconductor's exclusive, cost-effective, highly reliable Surmetic[™] package and is ideally suited for use in communication systems, automotive, numerical controls, process controls, medical equipment, business machines, power supplies and many other industrial/consumer applications.

Specification Features

- Working Peak Reverse Voltage Range 10 V to 78 V
- Standard Zener Breakdown Voltage Range 11.7 V to 91.3 V
- Peak Power 400 Watts @ 1 ms
- ESD Rating of Class 3 (> 16 kV) per Human Body Model
- Response Time is Typically < 1 ns
- Flat Handling Surface for Accurate Placement
- Package Design for Top Slide or Bottom Circuit Board Mounting
- Low Profile Package
- Pb–Free Packages are Available

Mechanical Characteristics:

CASE: Void-free, transfer-molded plastic

FINISH: All external surfaces are corrosion resistant and leads are readily solderable

MAXIMUM CASE TEMPERATURE FOR SOLDERING PURPOSES:

260°C for 10 Seconds

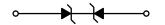
POLARITY: Cathode polarity notch does not indicate polarity **MOUNTING POSITION:** Any



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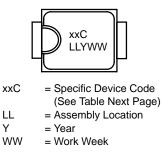
PLASTIC SURFACE MOUNT ZENER OVERVOLTAGE TRANSIENT SUPPRESSORS $10-78 V V_{R}$ **400 W PEAK POWER**





SMA CASE 403B PLASTIC

MARKING DIAGRAM



ORDERING INFORMATION

Device [*]	Package	Shipping [†]
1SMAxxCAT3	SMA	5000/Tape & Reel
1SMAxxCAT3G	SMA (Pb–Free)	5000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Individual devices are listed on page 3 of this data sheet.

*The "T3" suffix refers to a 13 inch reel.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) @ $T_L = 25^{\circ}C$, Pulse Width = 1 ms	P _{PK}	400	W
DC Power Dissipation @ T _L = 75°C Measured Zero Lead Length (Note 2) Derate Above 75°C Thermal Resistance from Junction–to–Lead	P _D R _{θJL}	1.5 20 50	W mW/°C °C/W
DC Power Dissipation (Note 3) @ T _A = 25°C Derate Above 25°C Thermal Resistance from Junction–to–Ambient	Ρ _D R _{θJA}	0.5 4.0 250	W mW/°C °C/W
Operating and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not imwww.DataSheet4plied, damage may occur and reliability may be affected.

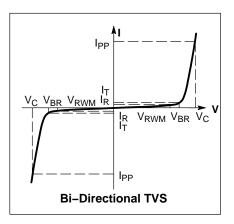
10 X 1000 μs, non-repetitive
 1" square copper pad, FR-4 board

FR-4 board, using ON Semiconductor minimum recommended footprint, as shown in 403B case outline dimensions spec.
 *Please see 1SMA5.0AT3 to 1SMA78AT3 for Unidirectional devices.

ELECTRICAL CHARACTERISTICS

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Symbol	Parameter				
I _{PP}	Maximum Reverse Peak Pulse Current				
V _C	Clamping Voltage @ I _{PP}				
V _{RWM}	Working Peak Reverse Voltage				
I _R	Maximum Reverse Leakage Current @ $\mathrm{V}_{\mathrm{RWM}}$				
V _{BR}	Breakdown Voltage @ I _T				
Ι _Τ	Test Current				



ELECTRICAL CHARACTERISTICS

		V _{RWM}		Breakdown Voltage			V _C @ I _{PP} (Note 6)		
	Device	(Note 4)	I _R @ V _{RWM}	V _{BR} (Volts) (Note 5)		@ կ	vc	I _{PP}	
	Marking	Volts	μΑ	Min	Nom	Max	mA	Volts	Amps
1SMA10CAT3	QXC	10	2.5	11.1	11.69	12.27	1.0	17.0	23.5
1SMA11CAT3	QZC	11	2.5	12.2	12.84	13.48	1.0	18.2	22.0
1SMA12CAT3	REC	12	2.5	13.3	14.00	14.70	1.0	19.9	20.1
1SMA13CAT3, G*	RGC	13	2.5	14.4	15.16	15.92	1.0	21.5	18.6
1SMA14CAT3	RKC	14	2.5	15.6	16.42	17.24	1.0	23.2	17.2
1SMA15CAT3, G*	RMC	15	2.5	16.7	17.58	18.46	1.0	24.4	16.4
1SMA16CAT3, G*	RPC	16	2.5	17.8	18.74	19.67	1.0	26.0	15.4
1SMA18CAT3	RTC	18	2.5	20	21.06	22.11	1.0	29.2	13.7
U.1SMA20CAT3, G*	RVC	20	2.5	22.2	23.37	24.54	1.0	32.4	12.3
1SMA22CAT3	RXC	22	2.5	24.4	25.69	26.97	1.0	35.5	11.3
1SMA24CAT3, G*	RZC	24	2.5	26.7	28.11	29.51	1.0	38.9	10.3
1SMA26CAT3, G*	SEC	26	2.5	28.9	30.42	31.94	1.0	42.1	9.5
1SMA28CAT3	SGC	28	2.5	31.1	32.74	34.37	1.0	45.4	8.8
1SMA30CAT3	SKC	30	2.5	33.3	35.06	36.81	1.0	48.4	8.3
1SMA33CAT3, G*	SMC	33	2.5	36.7	38.63	40.56	1.0	53.3	7.5
1SMA36CAT3, G*	SPC	36	2.5	40	42.11	44.21	1.0	58.1	6.9
1SMA40CAT3	SRC	40	2.5	44.4	46.74	49.07	1.0	64.5	6.2
1SMA43CAT3	STC	43	2.5	47.8	50.32	52.83	1.0	69.4	5.8
1SMA48CAT3	SXC	48	2.5	53.3	56.11	58.91	1.0	77.4	5.2
1SMA51CAT3	SZC	51	2.5	56.7	59.69	62.67	1.0	82.4	4.9
1SMA54CAT3	TEC	54	2.5	60	63.16	66.32	1.0	87.1	4.6
1SMA58CAT3, G*	TGC	58	2.5	64.4	67.79	71.18	1.0	93.6	4.3
1SMA60CAT3, G*	TKC	60	2.5	66.7	70.21	73.72	1.0	96.8	4.1
1SMA64CAT3	TMC	64	2.5	71.1	74.84	78.58	1.0	103	3.9
1SMA70CAT3	TPC	70	2.5	77.8	81.90	85.99	1.0	113	3.5
1SMA78CAT3	TTC	78	2.5	86.7	91.27	95.83	1.0	126	3.2

4. A transient suppressor is normally selected according to the working peak reverse voltage (V_{RWM}), which should be equal to or greater than the DC or continuous peak operating voltage level
5. V_{BR} measured at pulse test current I_T at an ambient temperature of 25°C
6. Surge current waveform per Figure 2 and derate per Figure 3

* The "G" suffix indicates Pb–Free package available.

RATING AND TYPICAL CHARACTERISTIC CURVES

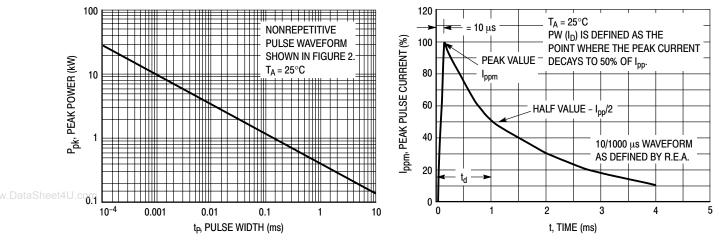


Figure 1. Pulse Rating Curve

Figure 2. Pulse Waveform

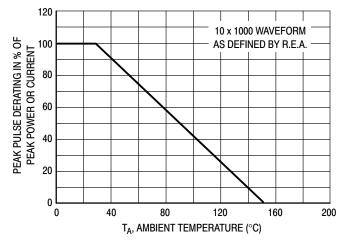
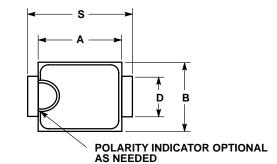


Figure 3. Pulse Derating Curve

OUTLINE DIMENSIONS

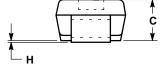
SMA CASE 403B-02 **ISSUE C**



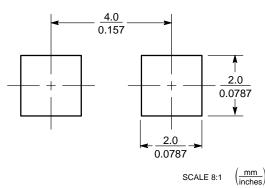
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 403B-01 OBSOLETE, NEW STANDARD 403B-02.

	INC	HES	MILLIMETERS		
DIM	MIN MAX		MIN	MAX	
Α	0.160	0.180	4.06	4.57	
В	0.090	0.115	2.29	2.92	
С	0.075	0.095	1.91	2.41	
D	0.050	0.064	1.27	1.63	
Η	0.002	0.006	0.05	0.15	
J	0.006	0.016	0.15	0.41	
Κ	0.030	0.060	0.76	1.52	
S	0.190	0.220	4.83	5.59	

κ



SOLDERING FOOTPRINT*



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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